

COMSOL
CONFERENCE
2020 NORTH AMERICA

Modeling On-chip Nanoscale Trap and Enhance Device for Quantum Photonics Using Comsol Multiphysics

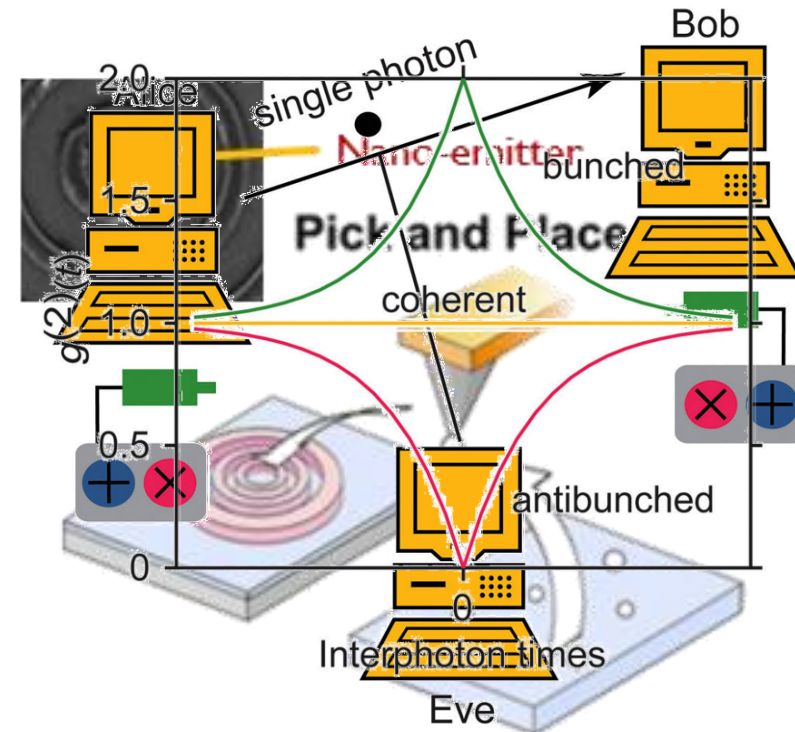
Samprity Saha, Dhruv Fomra, Nathaniel Kinsey

Dept. of Electrical and Computer Engineering, VCU, Richmond, VA, USA



Single Photon Source in Quantum Optics

- General idea
 - Emits only one photon at a time (antibunched)
 - Emitted photons are indistinguishable
 - Example: Q-dots, crystal NV center etc.
- Application
 - Quantum cryptography
 - Quantum computation
- Development challenge
 - Separate enhancement medium required
 - Complex to fabricate and integrate
 - Time consuming, non-scalable process

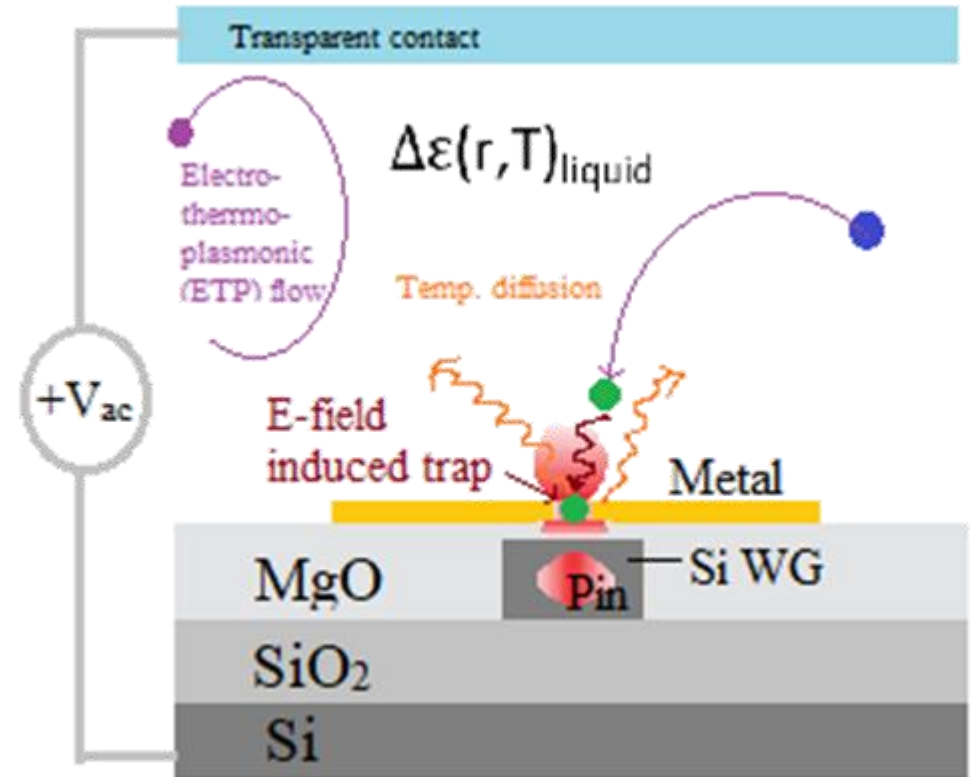
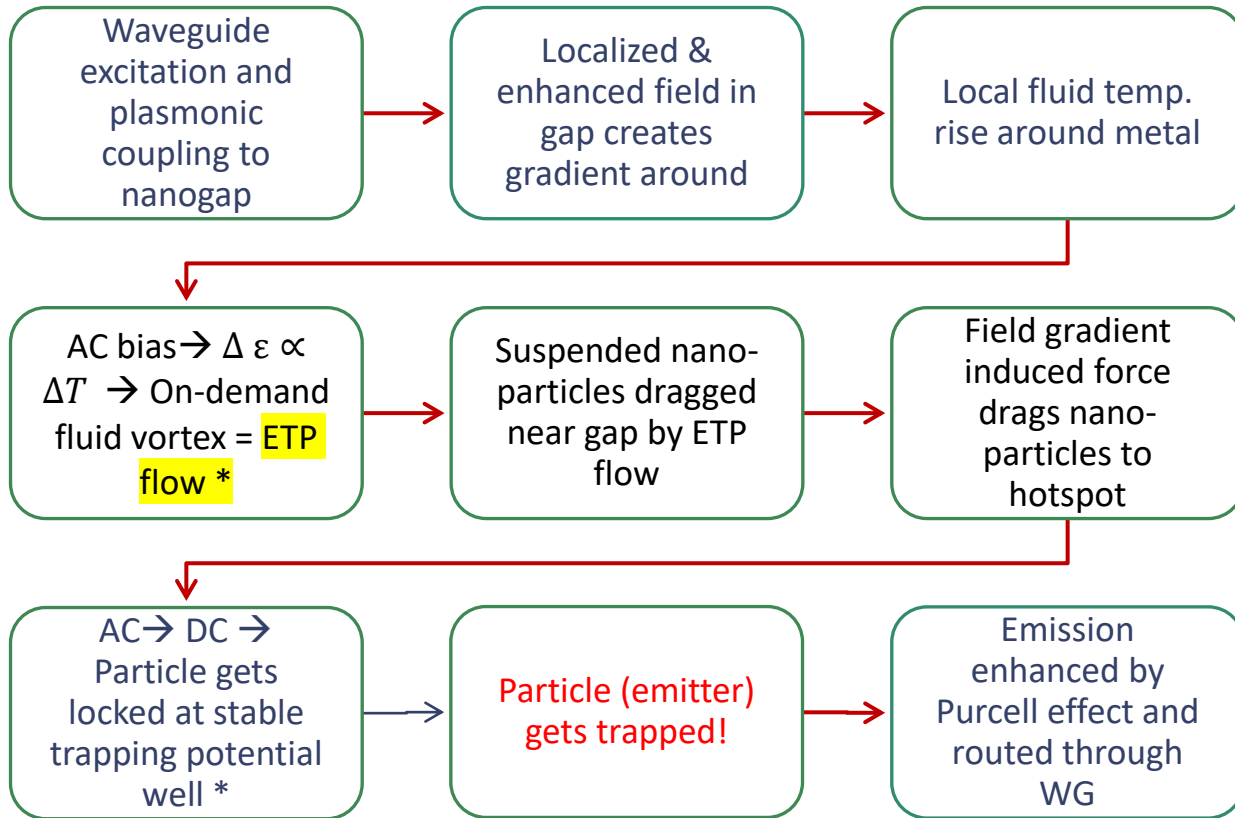


Difference between antibunched (SPS) and bunched (laser), and bunched (thermal/classical) light sources
ACS Photonics, 3, 9, 692–698 (2016)



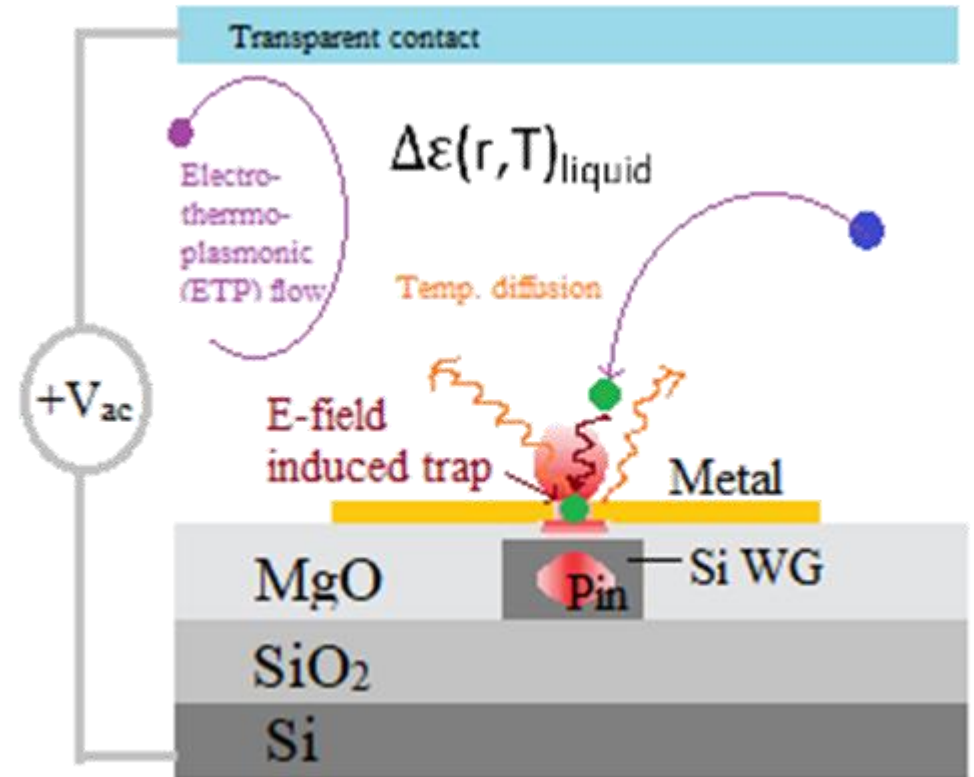
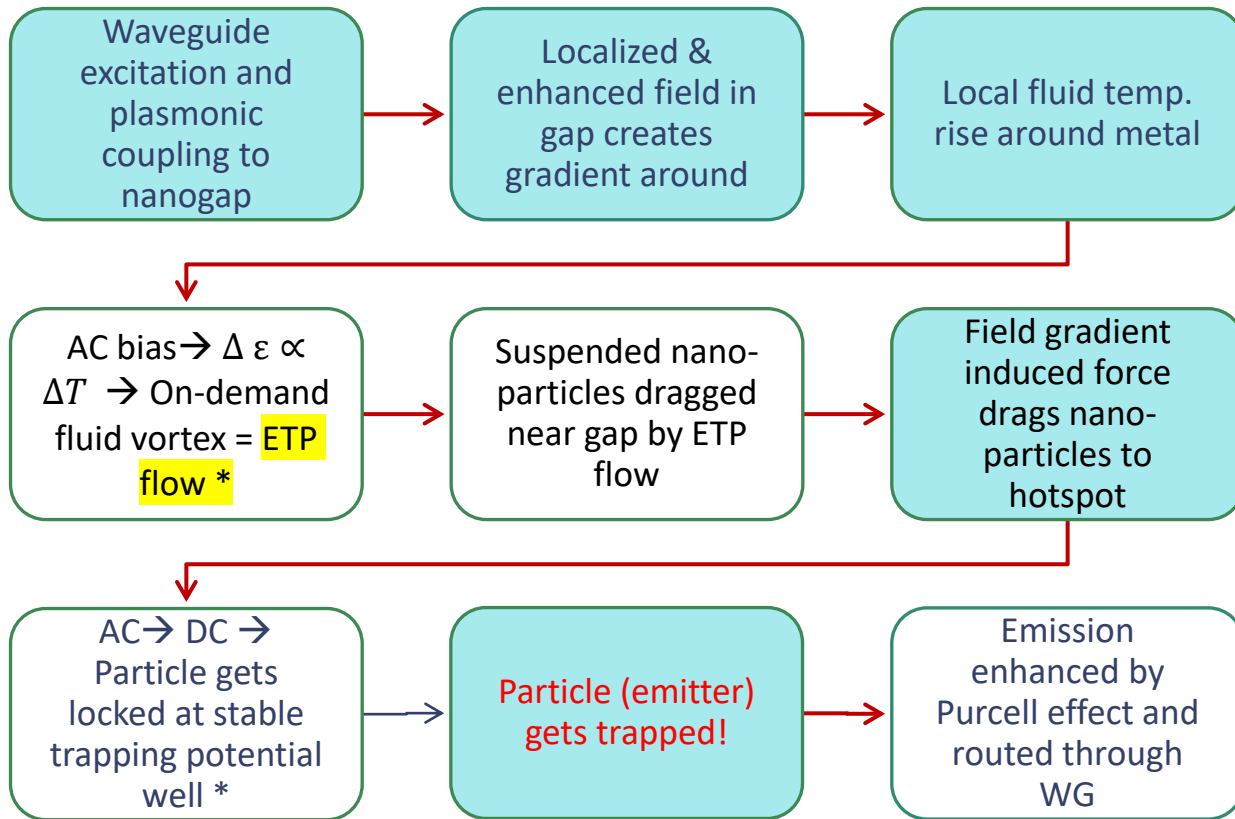
* J. C. Ndukaife et al, Long-range and rapid transport of individual nano-objects by a hybrid electro-thermo-plasmonic nano-tweezer, Nature Nanotechnology, 11, 1, 53–59 (2016).

Proposed Scheme



* J. C. Ndukaife et al, Long-range and rapid transport of individual nano-objects by a hybrid electro-thermo-plasmonic nano-tweezer, Nature Nanotechnology, 11, 1, 53–59 (2016).

Proposed Scheme



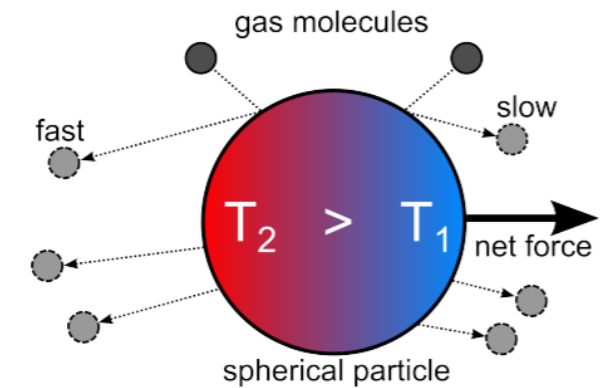
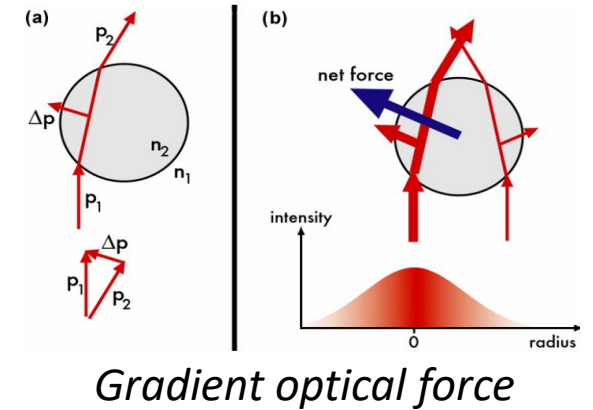
Goals and Challenges

- Investigate particle trapping ability
 - Trade off between power consumption, field strength confinement and particle size

$$\text{Trapping potential} = \int_{-\infty}^r \mathbf{F} \cdot d\mathbf{r} \propto \frac{\text{Input power} \times \text{Particle size} \times \text{Field gradient}}{\text{Gap size}}$$

(Note: The above equation only represents general dependence, not exact relation)

- Required trapping potential depth $\geq 10K_B T$ for stable trapping
- Check thermal feasibility of system operation
 - High excitation power \rightarrow higher plasmonic loss \rightarrow High temperature rise (ΔT) \rightarrow convective flow or thermophoretic force (big particle) acting oppositely \rightarrow reduces trap stability



Simulation set up

COMSOL Multiphysics module components:

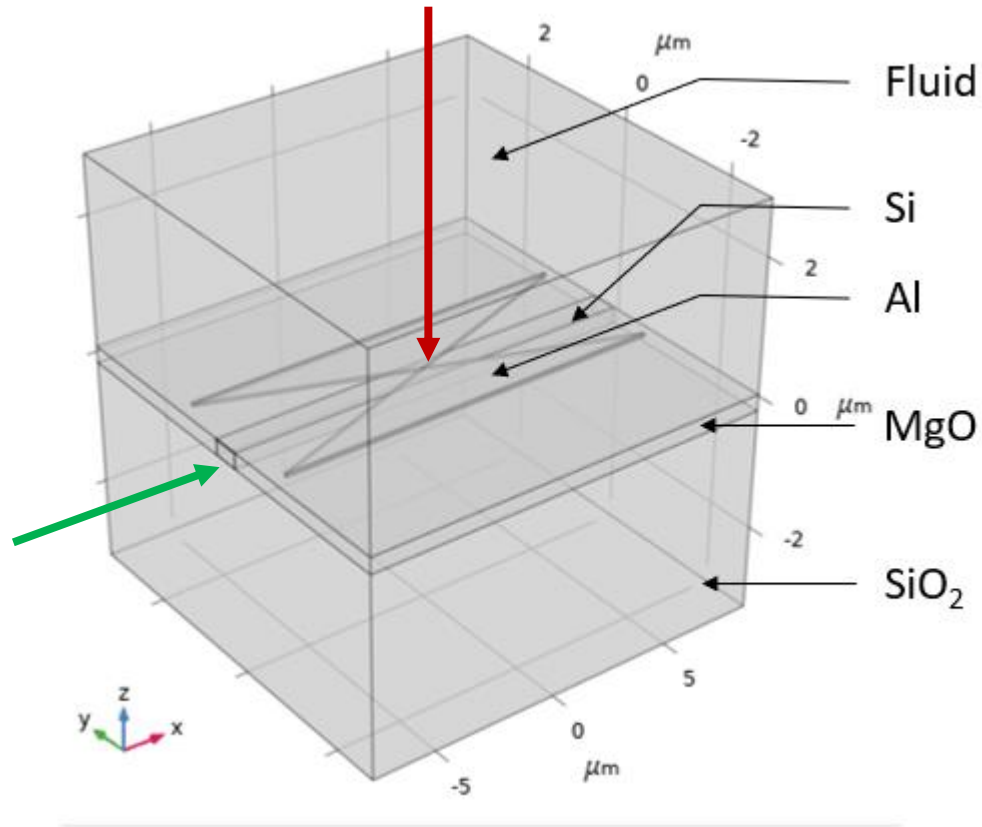
- i. Wave optics module
 - Scattering boundary condition
 - Full wave study
 - Used mesh control faces
- ii. Heat transfer in Solid
 - Convectational flow neglected
 - Liquid considered as solid

Material choice

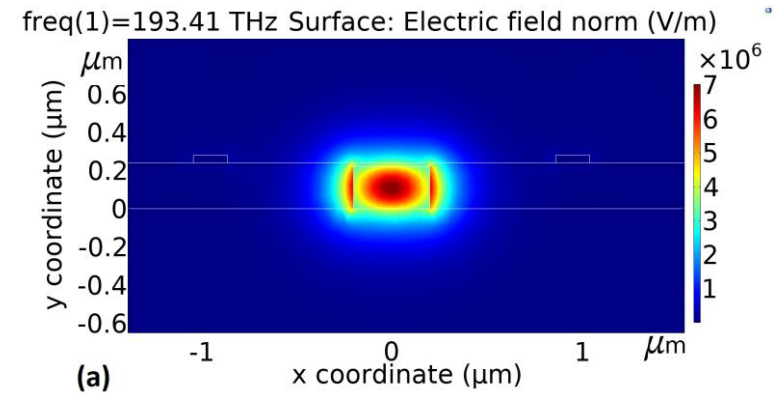
- i. Aluminum as metal (initially used TiN)
 - Smaller screen depth, more metallic
($\epsilon_{Al}(1.55 \mu\text{m}) = -242 + 49i$, $\delta_{Al} = \sim 8 \text{ nm}$;
 $\epsilon_{TiN}(1.55 \mu\text{m}) = -24 + 36i$, $\delta_{TiN} = \sim 21 \text{ nm}$)
 - Thermally conductive, better heat dissipation
($\kappa_{Al} = 237 \text{ W/m/K}$; $\kappa_{TiN} = 29 \text{ W/m/K}$)
- ii. Polystyrene as nano-particle
 - Good polarizability
 - Simplicity



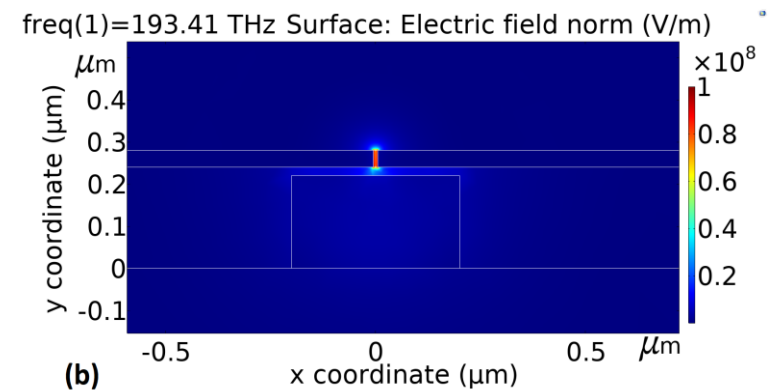
Mode coupling with hybrid waveguide



Photonic mode

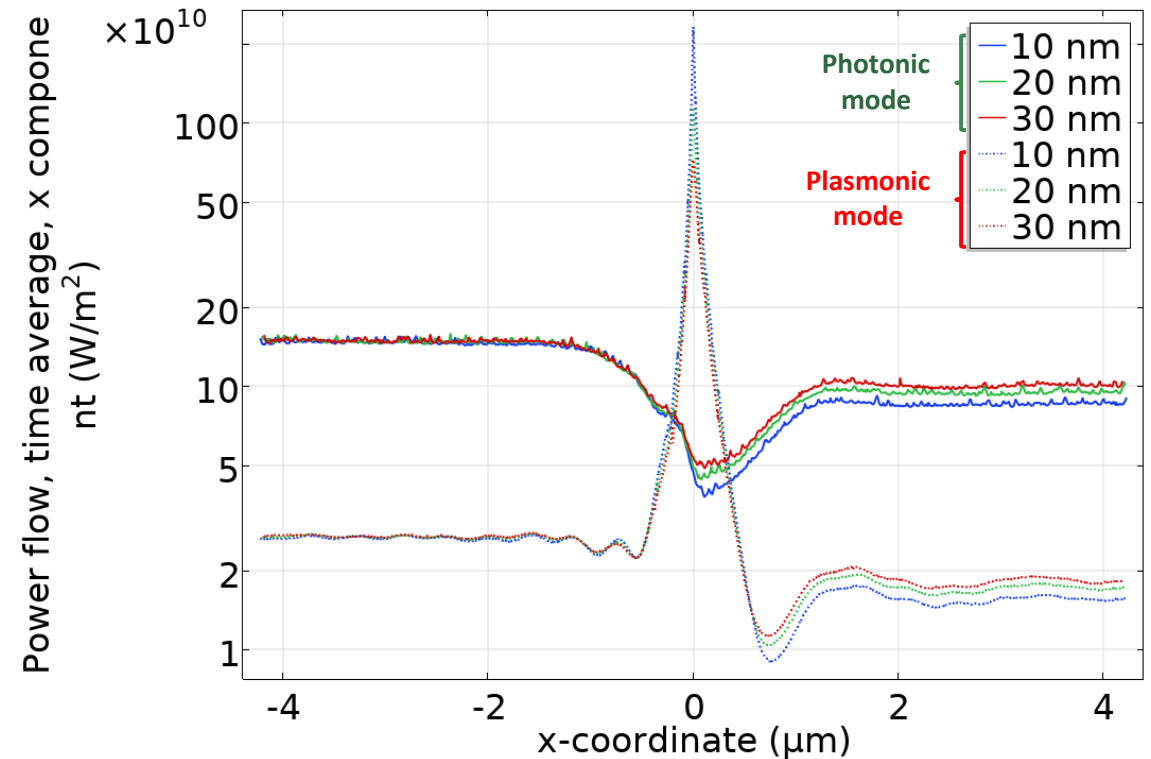
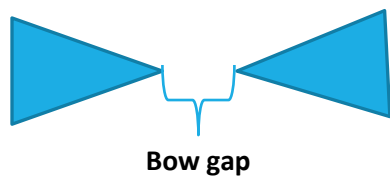


*Plasmonic/
hybrid MIM
mode*

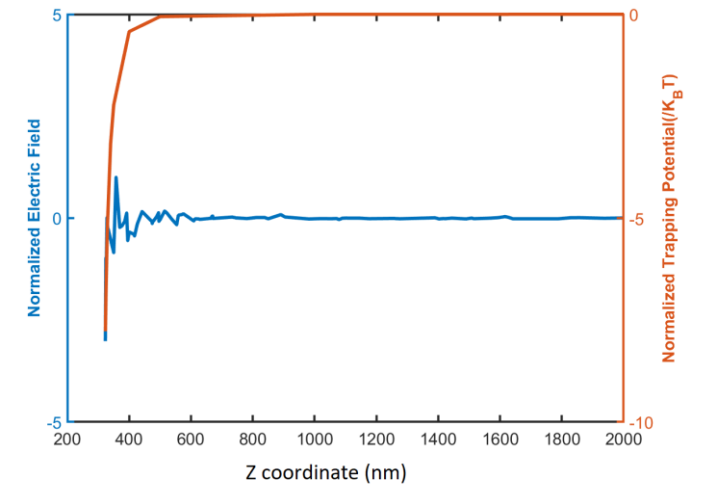
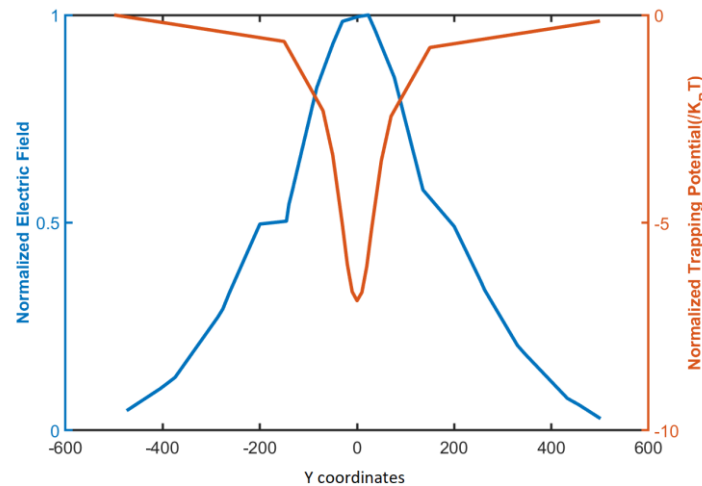
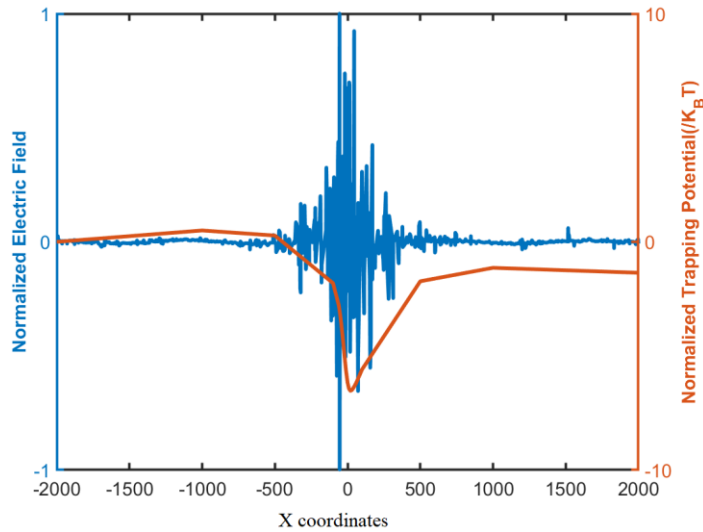
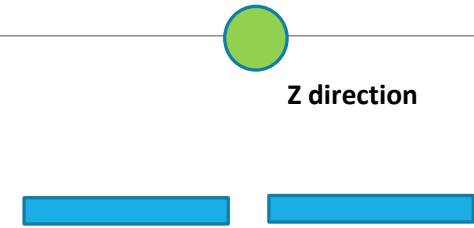
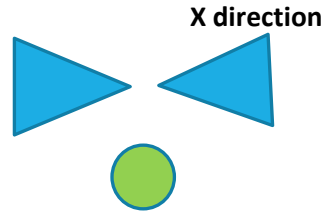


Power coupling efficiency

- Power transition gives an approximate idea of mode coupling strength
- Sharp, >10x enhancement of plasmonic mode power for smaller gap
- Insertion loss is between 30% to 50% for decreasing gap size (power input 8mW)
- Can be further optimized by tuning structure parameters

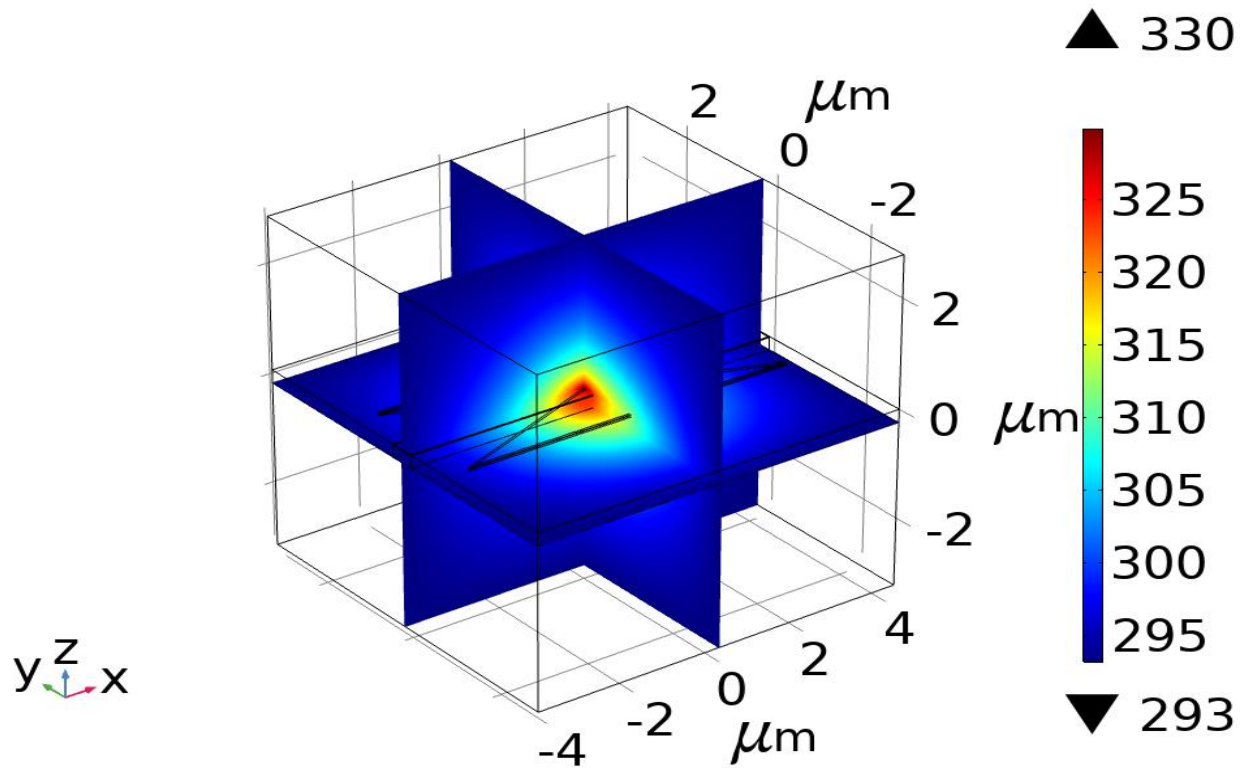


Field induced trap for nano-particle



Temperature profile

bow_gap = 30 nm Multislice: Temperature (K)



Conclusion

- ✓ Effective adiabatic conversion of injected photonic mode to highly confined and enhanced MIM mode is achieved with the geometry.
- ✓ The confined enhancement of field creates sharp field gradient leading to stronger force ($\propto E^2$).
- ✓ Capability to trap nano particles with support of ETP flow verified.
- ✓ Power flow transition between the distinguished modes indicative to effective emitter-waveguide coupling.

Future schemes:

- Efficient power coupling with lower input power (\rightarrow lower temperature)
- Investigation of Purcell factor and emission coupling
- Structural modification to accommodate additional heatsinks if required.
- Full process implementation in COMSOL Multiphysics combining AC/DC, Fluid mechanics along with wave optics and heat transfer modules.



Thank you

